

P-Channel Silicon MOSFET

General Description

These P-Channel enhancement mode power field effect transistors use advanced trench technology and design to provide excellent RDS(ON). This device is suitable for use as a load switch or in PWM applications.

Features

- Low On-Resistance
- 100% avalanche tested
- RoHS Compliant

Product Summary

BVDSS	RDSON	ID
-150V	150mΩ	-25A

Applications

- Active Clamp Switch
- Load Switch
- Portable equipment and battery powered systems

TO-252/251 Pin Configuration



Type	Package	Marking
CMD25P15	TO-252	CMD25P15
CMU25P15	TO-251	CMU25P15

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V_{DS}	Drain-Source Voltage	-150	V	
V_{GS}	Gate-Source Voltage	±20	V	
I _D @T _C =25℃	Continuous Drain Current	-25	Α	
I _D @T _C =100℃	Continuous Drain Current	-17.5	А	
I _{DM}	Pulsed Drain Current	-100	А	
EAS	Single Pulse Avalanche Energy ¹	115	mJ	
P _D @T _C =25°C	Total Power Dissipation	90	W	
T _{STG}	Storage Temperature Range -55 to 150		°C	
T_J	Operating Junction Temperature Range -55 to 150		$^{\circ}$	

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit	
$R_{ heta JA}$	Junction-to-Ambient		62.5	°C/W	
$R_{ heta JC}$	Junction-to-Case (Drain)		1.39	°C/W	

CMD25P15/CMU25P15



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Electrical Characteristics (T $_{J}$ =25 $^{\circ}$ C , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-150			V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-10V, I _D =-12.5A		128	150	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =-250uA	-2		-4	V
I _{DSS}	Drain-Source Leakage Current	V_{DS} =-150V, V_{GS} =0V, T_J =25°C			-1	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS} = \pm 20V$, $V_{DS} = 0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =-10V , I _D =-12.5A		25		S
Qg	Total Gate Charge	V _{DS} =-80V, I _D =-12.5A V _{GS} =-10V		60		
Q_gs	Gate-Source Charge			9		nC
Q_{gd}	Gate-Drain Charge			17		
T _{d(on)}	Turn-On Delay Time			11		
Tr	Rise Time	V_{DS} =-50V, V_{GS} =-10V, R_{G} =3.3 Ω		26		
T _{d(off)}	Turn-Off Delay Time	I _D =-12.5A , R _D =4.2Ω		67		ns
T _f	Fall Time			60		
C _{iss}	Input Capacitance	V _{DS} =-25V, V _{GS} =0V , f=1MHz		4200		
Coss	Output Capacitance			120		pF
C _{rss}	Reverse Transfer Capacitance			110		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	-V _G =V _D =0V , Force Current			-25	Α
I _{SM}	Pulsed Source Current				-100	Α
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =-25A		-0.9	-1.2	V

Notes:

1. The EAS data shows Max. rating . The test condition is VDS=-30V, VGS=-10V, L=0.5mH, IAS=-21.6A.

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